



ON Semiconductor®

FDS4465-F085

P-Channel 1.8V Specified PowerTrench MOSFET

General Description

This P-Channel 1.8V specified MOSFET is a rugged gate version of ON Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (1.8V - 8V).

Applications

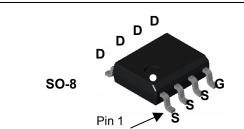
- Power management
- Load switch
- Battery protection

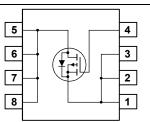


Features

 $\label{eq:rescaled} \begin{array}{l} \bullet \ -13.5 \ \text{A}, \ -20 \ \text{V}. & R_{\text{DS}(\text{ON})} = 8.5 \ \text{m} \Omega \ \textcircled{0} \ \text{V}_{\text{GS}} = -4.5 \ \text{V} \\ & R_{\text{DS}(\text{ON})} = 10.5 \ \text{m} \Omega \ \textcircled{0} \ \text{V}_{\text{GS}} = -2.5 \ \text{V} \\ & R_{\text{DS}(\text{ON})} = 14 \ \text{m} \Omega \ \textcircled{0} \ \text{V}_{\text{GS}} = -1.8 \ \text{V} \end{array}$

- Fast switching speed
- High performance trench technology for extremely low R_{DS(ON)}
- High current and power handling capability
- Qualified to AEC Q101
- RoHS Compliant





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
I _D	Drain Current – Continuous	(Note 1a)	-13.5	А
	– Pulsed		-50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	–55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	85	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

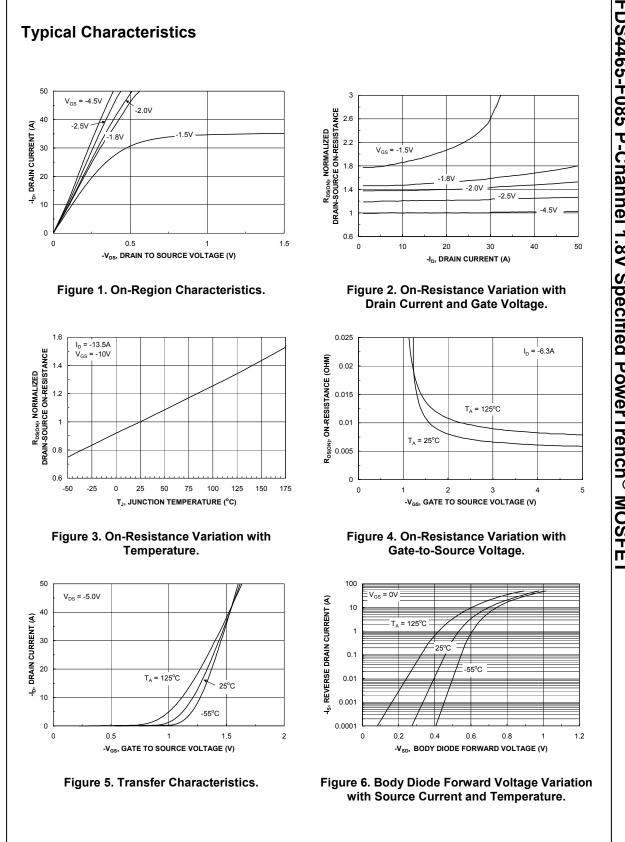
Device Marking Device Reel Size Tape width Quantity FDS4465 FDS4465-F085 13" 12mm 2500 unit	_		– – –			0
FDS4465 FDS4465-F085 13" 12mm 2500 unit	_	Device Marking	Device	Reel Size	Tape width	Quantity
		FDS4465	FDS4465-F085	13"	12mm	2500 units

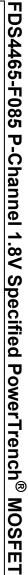
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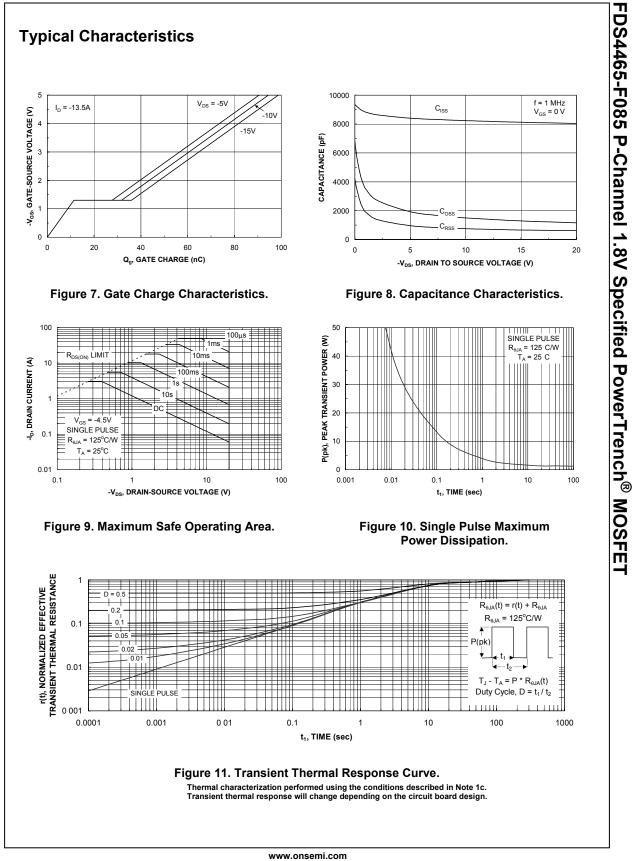
Publication Order Number: FDS4465-F085/D

	Test Conditions	Min	Тур	Мах	Units
octeristics					
Drain–Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-20			V
Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-12		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
Gate–Body Leakage, Reverse	$V_{GS} = -8 V, \qquad V_{DS} = 0 V$			-100	nA
ICTERISTICS (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.6	-1.5	V
Gate Threshold Voltage Temperature Coefficient	I_D = –250 µA, Referenced to 25°C		3		mV/°C
Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS}=-4.5 \ V, I_{D}=-13.5 \ A \\ V_{GS}=-2.5 \ V, I_{D}=-12 \ A \\ V_{GS}=-1.8 \ V, I_{D}=-10.5 \ A \\ V_{GS}=-4.5 \ V, \ I_{D}=-13.5 \ A, \ T_{J}=125^{\circ} C \end{array} $		6.7 8.0 9.8 9.0	8.5 10.5 14 13	mΩ
On–State Drain Current	$V_{GS} = -4.5 V$, $V_{DS} = -5 V$	-50			А
Forward Transconductance	$V_{DS} = -5 V$, $I_D = -13.5 A$		70		S
Characteristics					
Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		8237		pF
Output Capacitance	f = 1.0 MHz		1497		pF
Reverse Transfer Capacitance			750		pF
Characteristics (Note 2)					
Turn–On Delay Time	$V_{DD} = -10V$, $I_D = -1 A$,		20	36	ns
Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		24	38	ns
Turn–Off Delay Time	-		300	480	ns
Turn–Off Fall Time			140	224	ns
Total Gate Charge	$V_{DS} = -10 V$, $I_D = -13.5 A$,		86	120	nC
Gate–Source Charge	V_{GS} = -4.5 V		20		nC
Gate–Drain Charge			11		nC
urce Diode Characteristics	and Maximum Ratings				
Maximum Continuous Drain-Source	Diode Forward Current			-2.1	А
Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = -2.1 A$ (Note 2)		-0.6	-1.2	V
	Gate-Body Leakage, Reverse Cteristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain-Source On-Resistance On-State Drain Current Forward Transconductance Characteristics Input Capacitance Output Capacitance Qutput Capacitance Characteristics (Note 2) Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Drain Charge urce Diode Characteristics	Gate-Body Leakage, Forward $V_{GS} = 8 \text{ V}$, $V_{DS} = 0 \text{ V}$ Gate-Body Leakage, Reverse $V_{GS} = -8 \text{ V}$, $V_{DS} = 0 \text{ V}$ Cteristics(Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \mu \text{A}$ Gate Threshold Voltage $I_D = -250 \mu \text{A}$, Referenced to 25°CTemperature Coefficient $I_D = -250 \mu \text{A}$, Referenced to 25°CStatic Drain-Source $V_{GS} = -4.5 \text{ V}$, $I_D = -13.5 \text{ A}$ On-Resistance $V_{GS} = -4.5 \text{ V}$, $I_D = -10.5 \text{ A}$ $V_{GS} = -4.5 \text{ V}$, $I_D = -13.5 \text{ A}$ On-State Drain Current $V_{GS} = -4.5 \text{ V}$, $V_{DS} = -5 \text{ V}$ Forward Transconductance $V_{DS} = -5 \text{ V}$, $I_D = -13.5 \text{ A}$ CharacteristicsInput Capacitance $V_{DS} = -10 \text{ V}$, $V_{GS} = 0 \text{ V}$,Gutput Capacitance $V_{DS} = -10 \text{ V}$, $V_{GS} = 0 \text{ V}$,furm-On Delay Time $V_{DD} = -100 \text{ V}$, $I_D = -13.6 \Omega$ Turn-On Rise Time $V_{DS} = -10 \text{ V}$, $I_D = -1 \text{ A}$,Turn-Off Delay Time $V_{DS} = -4.5 \text{ V}$, $R_{GEN} = 6 \Omega$ Turn-Off Fall Time $V_{DS} = -10 \text{ V}$, $I_D = -13.5 \text{ A}$,Gate-Source Charge $V_{DS} = -10 \text{ V}$, $I_D = -13.5 \text{ A}$,	Gate-Body Leakage, Forward $V_{GS} = 8 V$, $V_{DS} = 0 V$ Gate-Body Leakage, Reverse $V_{GS} = -8 V$, $V_{DS} = 0 V$ Cteristics(Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ A -0.4 Gate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C -0.4 Gate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C -0.4 Gate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C -0.4 Gate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C -0.4 Static Drain-Source $V_{GS} = -4.5 \ V$, $I_D = -13.5 \ A$ $V_{GS} = -2.5 \ V$, $I_D = -12 \ A$ $V_{GS} = -4.5 \ V$, $I_D = -13.5 \ A$, $V_{GS} = -3 \ V$, $I_D = -13.5 \ A$ -50 Forward Transconductance $V_{DS} = -5 \ V$, $I_D = -13.5 \ A$ -50 Forward Transconductance $V_{DS} = -5 \ V$, $I_D = -13.5 \ A$ -50 CharacteristicsNote 2) $I_D = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -13.5 \ A$ Input Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -13.5 \ A$ Characteristics (Note 2) $I_D = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -13.5 \ A$ Turn-On Delay Time $V_{DD} = -10 \ V$, $V_{GS} = 0 \ Q$ $I_D = -13.5 \ A$ Turn-On Rise Time $V_{DS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ $I_D = -13.5 \ A$,Turn-Off Delay Time $V_{DS} = -10 \ V$, $I_D = -13.5 \ A$, $I_D = -13.5 \ A$,Turn-Off Fall Time $I_D = -13.5 \ A$, $I_D = -13.5 \ A$,Gate-Source Charge $V_{GS} = -4.5 \ V$ $I_D = -13.5 \ A$,	Gate-Body Leakage, Forward $V_{GS} = 8 V$, $V_{DS} = 0 V$ Image: Constraint of the system of th	Gate-Body Leakage, Forward $V_{GS} = 8 V$, $V_{DS} = 0 V$ 100 Gate-Body Leakage, Reverse $V_{GS} = -8 V$, $V_{DS} = 0 V$ -100 Cteristics (Note 2)

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